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- EPIC™ (Enhanced-Performance Implanted CMOS) 2-µ Process
- Typical V_{OLP} (Output Ground Bounce)
 < 0.8 V at V_{CC}, T_A = 25°C
- Typical V_{OHV} (Output V_{OH} Undershoot)
 > 2 V at V_{CC}, T_A = 25°C
- ESD Protection Exceeds 2000 V Per MIL-STD-883C, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- Latch-Up Performance Exceeds 250 mA Per JEDEC Standard JESD-17
- Package Options Include Plastic Small-Outline (D), Shrink Small-Outline (DB), Thin Shrink Small-Outline (PW), Ceramic Flat (W) Packages, Chip Carriers (FK), and (J) 300-mil DIPs

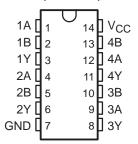
description

These quadruple 2-input positive-OR gates are designed for 2.7-V to 5.5-V V_{CC} operation.

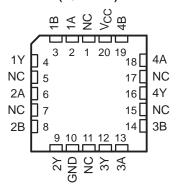
The 'LV32 perform the Boolean function Y = A + B or $Y = \overline{\overline{A} \cdot \overline{B}}$ in positive logic.

The SN74LV32 is packaged in Tl's shrink small-outline package (DB), which provides the same I/O pin count and functionality of standard small-outline packages in less than half the printed-circuit-board area.

SN54LV32...J OR W PACKAGE SN74LV32...D, DB, OR PW PACKAGE (TOP VIEW)



SN54LV32 . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

The SN54LV32 is characterized for operation over the full military temperature range of –55°C to 125°C. The SN74LV32 is characterized for operation from –40°C to 85°C.

FUNCTION TABLE (each gate)

_											
	INP	UTS	OUTPUT								
	Α	В	Υ								
Γ	Н	Х	Н								
l	Χ	Н	Н								
l	L	L	L								



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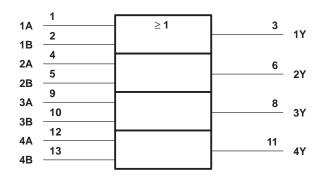


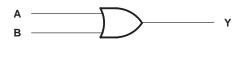
SN54LV32, SN74LV32 QUADRUPLE 2-INPUT POSITIVE-OR GATES

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logic symbol†

logic diagram, each gate (positive logic)





Pin numbers shown are for D, DB, J, PW, and W packages.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)‡

Supply voltage range, V _{CC}	$-0.5\ V$ to $7\ V$
Input voltage range, V _I (see Note 1)	-0.5 V to V _{CC} + 0.5 V
Output voltage range, V _O (see Notes 1 and 2)	$-0.5 \text{ V to V}_{CC} + 0.5 \text{ V}$
Input clamp current, I_{IK} ($V_I < 0$ or $V_I > V_{CC}$)	±20 mA
Output clamp current, I_{OK} ($V_O < 0$ or $V_O > V_{CC}$)	$\dots \dots \pm 50 \text{ mA}$
Continuous output current, I_O ($V_O = 0$ to V_{CC})	$\dots \dots \pm 25 \text{ mA}$
Continuous current through V _{CC} or GND	$\dots \dots \pm 50 \text{ mA}$
Maximum power dissipation at $T_A = 55^{\circ}C$ (in still air) (see Note 3): D package	1.25 W
DB or PW package	e 0.5 W
Storage temperature range, T _{stq}	

[‡] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
 - 2. This value is limited to 7 V maximum.
 - 3. The maximum package power dissipation is calculated using a junction temperature of 150°C and a board trace length of 750 mils.

[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

recommended operating conditions (see Note 4)

			SN54	SN54LV32		SN74LV32	
			MIN	MAX	MIN	MAX	UNIT
Vсс	Supply voltage		2.7	5.5	2.7	5.5	V
\/	High-level input voltage	$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	2		2		V
VIH	nigri-level iriput voltage	$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$	3.15		3.15		V
VIL	Low level input voltage	$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$		0.8		0.8	V
	Low-level input voltage	$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$		1.65		1.65	
٧ı	Input voltage		0 4	Vcc	0	VCC	V
Vo	Output voltage		0	VCC	0	VCC	V
la	High lovel output ourrent	$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	20	-6		-6	mA
IОН	High-level output current	$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$	180	-12		-12	IIIA
la.	Low level output ourrent	$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	V	6		6	mA
IOL	Low-level output current V _{CC} = 4.5 V to 5.5 V			12		12	IIIA
Δt/Δν	Input transition rise or fall rate		0	100	0	100	ns/V
T _A	Operating free-air temperature		-55	125	-40	85	°C

NOTE 4: Unused inputs must be held high or low to prevent them from floating.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	TEST CONDITIONS			SN54LV32			SN74LV32			
PARAMETER			v _{cc} †	MIN	TYP	MAX	MIN	TYP	MAX	UNIT
	I _{OH} = -100 μA	MIN to MAX	V _{CC} -0.	.2		V _{CC} -0.	2			
Voн	I _{OH} = -6 mA	I _{OH} = -6 mA					2.4			V
	$I_{OH} = -12 \text{ mA}$	4.5 V	3.6			3.6				
	I _{OL} = 100 μA	MIN to MAX			0.2			0.2		
VOL	$I_{OL} = 6 \text{ mA}$	3 V			0.4			0.4	V	
	I _{OL} = 12 mA	4.5 V			0.55			0.55		
1.	V _I = V _{CC} or GND		3.6 V		- 2	∜ ±1			±1	
ΙΙ			5.5 V		PA.	±1			±1	μΑ
laa	Vi – Va a or CND	10 - 0	3.6 V		7	20			20	
^l cc	$V_I = V_{CC}$ or GND	IO = 0	5.5 V		5	20			20	μΑ
ΔICC	One input at V _{CC} – 0.6 V	One input at V _{CC} – 0.6 V	3 V to 3.6 V	PRO)	500			500	μΑ
0:	V _I = V _{CC} or GND		3.3 V		2.5			2.5		
C _i			5 V		2			2		pF

[†] For conditions shown as MIN or MAX, use the appropriate values under recommended operating conditions.

switching characteristics over recommended operating free-air temperature range, $C_L = 50 \text{ pF}$ (unless otherwise noted) (see Figure 1)

			SN54LV32								
PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CC} = 5 V ± 0.5 V			VCC = 3.3 V ± 0.3 V			Vcc =	UNIT	
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	MAX	
t _{pd}	А	Y		6	10		9	13		16	ns

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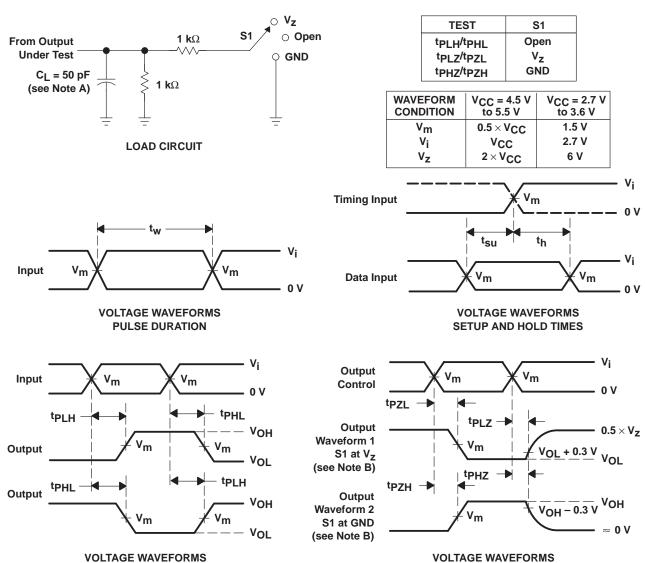
switching characteristics over recommended operating free-air temperature range, C_L = 50 pF (unless otherwise noted) (see Figure 1)

						SN74	LV32				
PARAMETER	FROM (INPUT)	TO (OUTPUT)	V_{CC} = 5 V \pm 0.5 V		V_{CC} = 3.3 V \pm 0.3 V			V _{CC} = 2.7 V		UNIT	
			MIN	TYP	MAX	MIN	TYP	MAX	MIN	MAX	
t _{pd}	А	Y		6	10		9	13		16	ns

operating characteristics, $T_A = 25^{\circ}C$

PARAMETER		TEST CONDITIONS	VCC	TYP	UNIT
C _{pd} Power dissipation capacitance per gate	Dower dissipation consoitance per gate	C ₁ = 50 pF. f = 10 MHz	3.3 V	23	pF
	$C_L = 50 \text{ pF}, \qquad f = 10 \text{ MHz}$	5 V	27	pr pr	

PARAMETER MEASUREMENT INFORMATION



PROPAGATION DELAY TIMES INVERTING AND NONINVERTING OUTPUTS

VOLTAGE WAVEFORMS ENABLE AND DISABLE TIMES LOW- AND HIGH-LEVEL ENABLING

NOTES: A. C_L includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Z_O = 50 Ω , $t_f \leq$ 2.5 ns, $t_f \leq$ 2.5 ns.
- D. The outputs are measured one at a time with one transition per measurement.
- E. tpLz and tpHz are the same as tdis.
- F. tpzL and tpzH are the same as ten.
- G. tpLH and tpHL are the same as tpd.

Figure 1. Load Circuit and Voltage Waveforms



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